

**AMENDMENTS TO THE SPECIFICATION**

Please delete the section heading beginning at page 1, line 1.

Please replace the section heading beginning at page 6, line 1, with the following rewritten section heading:

-- ~~DISCLOSURE~~ SUMMARY OF THE INVENTION --

Please replace the paragraphs beginning at page 8, line 15 and ending at page 9, line 1 with the following rewritten paragraphs:

-- Fig. 1 is a schematic view showing an apparatus for processing a film carrier tape for mounting an electronic component which comprises a spacer take-up device according to the present invention-;

Fig. 2 is a schematic view showing the state of a reel subjected to take-up by the spacer take-up device according to the present invention-;

Fig. 3 is a schematic view showing a conventional spacer take-up device-; and

~~Fig. 4 is a~~ Figs. 4(A) and 4(B) are schematic view views showing the state of a reel subjected to take-up by the conventional spacer take-up device. --

Please replace the section heading beginning at page 9, line 3, with the following rewritten section heading:

-- ~~BEST MODE FOR CARRYING OUT~~ DETAILED DESCRIPTION OF  
THE INVENTION --

Please delete the section heading beginning at page 16, line 16.